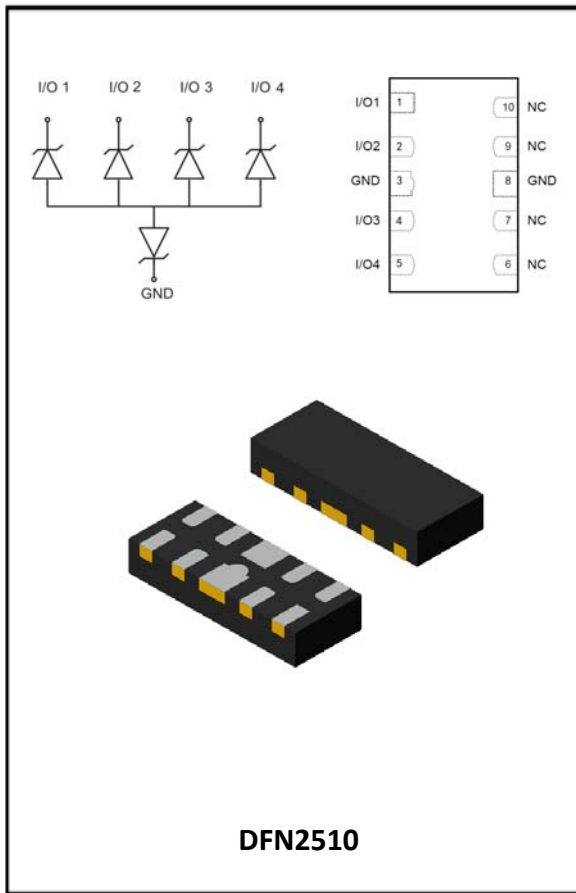


4-Line, Bi-directional, Ultra-low Capacitance, Transient Voltage Suppressor



Features

- Stand-off voltage: 1.5V Max
- Transient protection for each line according to IEC61000-4-2(ESD): $\pm 15\text{kV}$ (contact) IEC61000-4-5(surge): 7A (8/20 μs)
- Ultra-low capacitance: $C_J = 0.22\text{ pF}$ typ
- Low leakage current
- Low clamping voltage
- Up to 4 lines protects
- RoHS Compliant

Applications

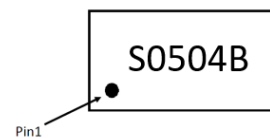
- HDMI 2.0/2.1, USB 3.0/3.1 Type C
- Monitors and flat panel displays
- Set-top box and Digital TV
- MDDI ports
- Video graphics cards
- Digital Video Interface (DVI)
- Notebook Computers
- PCI Express and Serial SATA Ports

Caution:

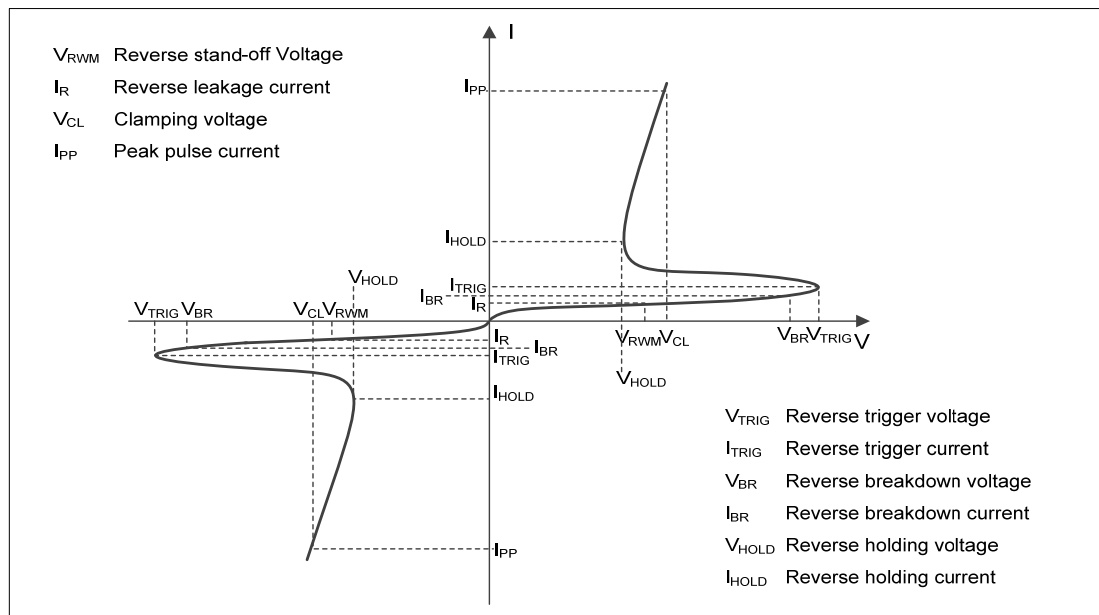
This Device is designed for signal line protection only. Not intended to be used under bias, not for application with a power line.

Mechanical Data

- Lead Finish: Matte Tin
- Case Material: "Green" Molding Compound.
- Moisture Sensitivity: Level 3 per J-STD-020
- Marking Information: See Below



■ Definitions of electrical characteristics





SESDULC1E04P5B

■Maximum Ratings

PARAMETER	SYMBOL	LIMITS	UNIT
Peak pulse power ($t_p = 8/20\mu s$)	P_{pk}	56	W
Peak pulse current ($t_p = 8/20\mu s$)	I_{pp}	7	A
ESD according to IEC61000-4-2 air discharge	V_{ESD}	± 15	KV
ESD according to IEC61000-4-2 contact discharge		± 15	
Junction temperature	T_J	-55~125	$^{\circ}C$
Storage temperature	T_{STG}	-55~150	$^{\circ}C$

■Electrical Characteristics ($T_a=25^{\circ}C$ Unless otherwise specified)

PARAMETER	Symbol	UNIT	Conditions	Min	Typ	Max
Reverse maximum working voltage	V_{RWM}	V	Any I/O pin to ground			1.5
Reverse leakage current	I_R	nA	$V_{RWM} = 1.5V$, any I/O pin to ground			200
Reverse breakdown voltage	$V_{(BR)}$	V	$I_T = 1mA$, any I/O pin to ground	6.0	7.6	10.0
Reverse holding voltage	V_{HOLD}	V	$I_{HOLD} = 50mA$, any I/O pin to ground	2		
Clamping voltage ¹⁾	V_{CL}	V	$I_{PP} = 16A$, $t_p = 100ns$		6.5	
Clamping voltage ²⁾	V_{CL}	V	$I_{PP} = 1A$, $t_p = 8/20\mu s$		3	5
		V	$I_{PP} = 7A$, $t_p = 8/20\mu s$		6.5	8
Junction capacitance	CJ	pF	$V_R = 0V$, $f = 1MHz$ Any I/O pin to GND		0.22	0.28
			$V_R = 1.5V$, $f = 1MHz$ Any I/O pin to GND		0.2	0.26

Notes:

- 1) TLP parameter: $Z_0 = 50\Omega$, $t_p = 100ns$, $t_r = 2ns$, averaging window from 60ns to 80ns.
- 2) Non-repetitive current pulse, according to IEC61000-4-5.

■Ordering Information (Example)

PREFERED P/N	PACKING CODE	UNIT WEIGHT(mg)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
SESDULC1E04P5B	F1	Approximate 3.48	3000	30000	120000	7 reel



■ Characteristics (Typical)

Fig.1 8/20 μ s waveform per IEC61000-4-5

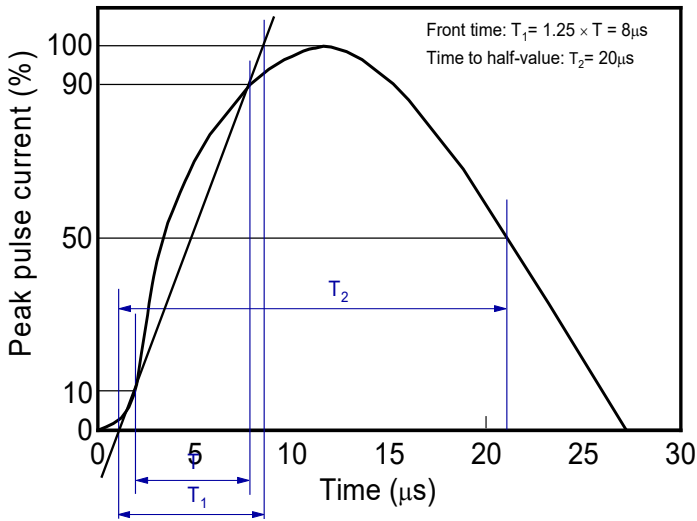


Fig.2 Contact discharge current waveform per IEC61000-4-2

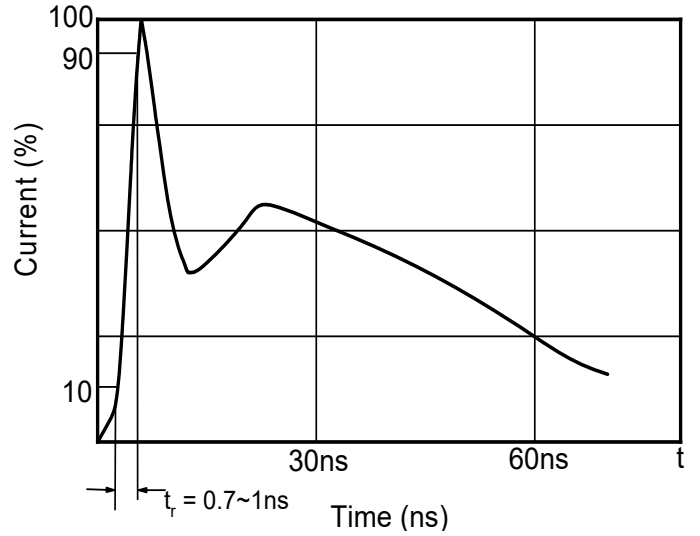


Fig.3 Clamping voltage vs. Peak pulse current

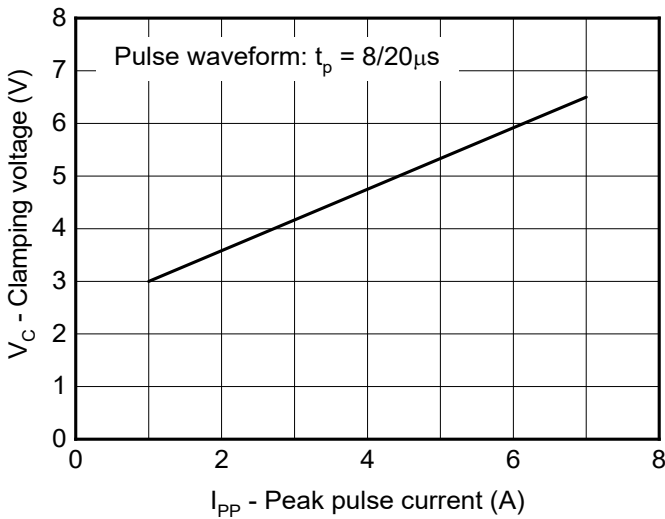


Fig.4 Capacitance vs. Reverse voltage

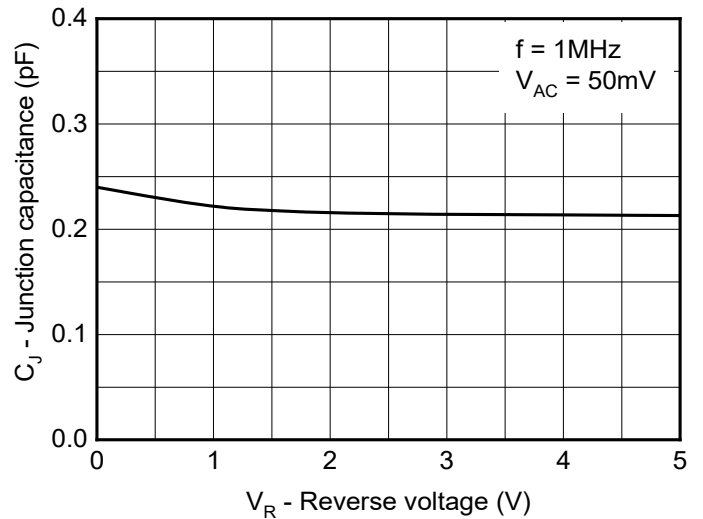


Fig.5 Non-repetitive peak pulse power vs. Pulse time

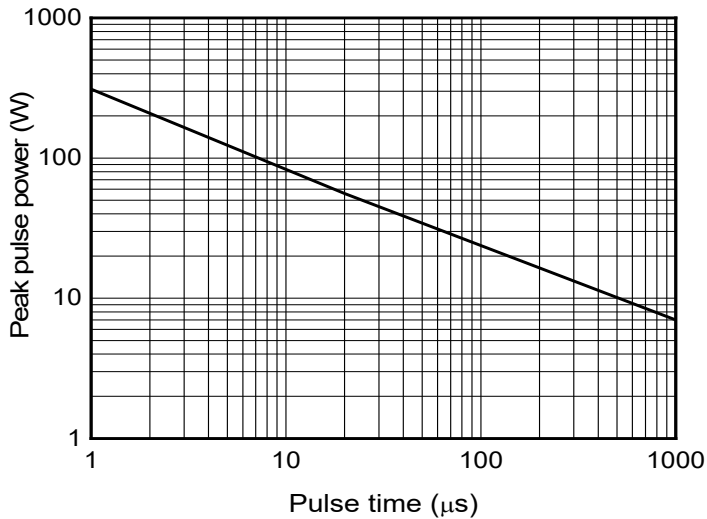


Fig.6 Power derating vs. Ambient temperature

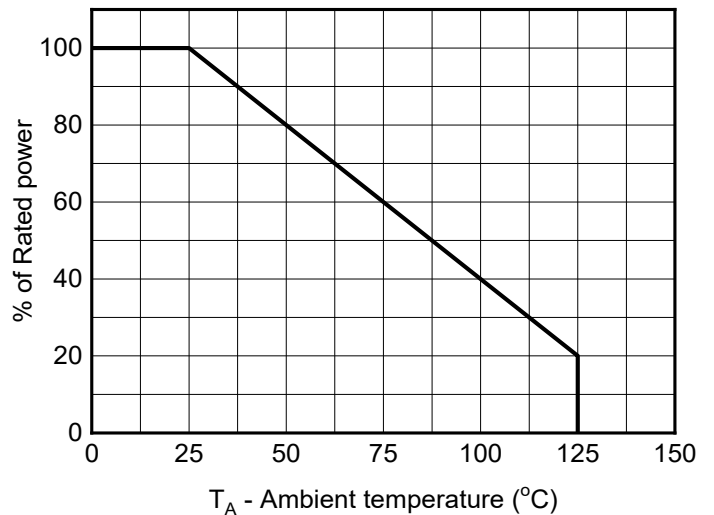
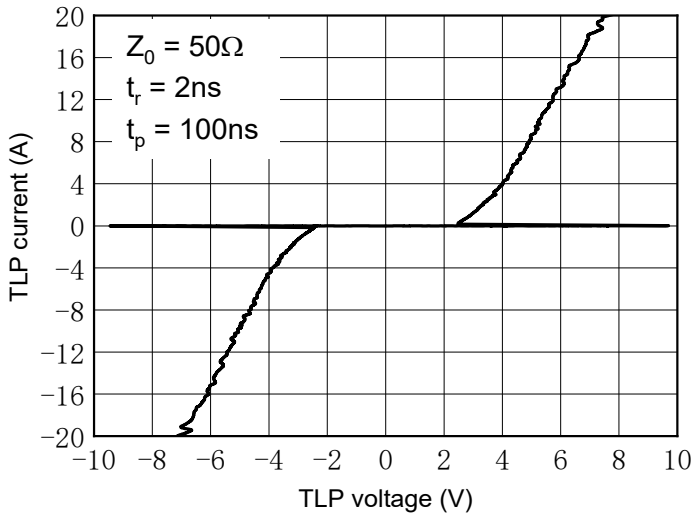
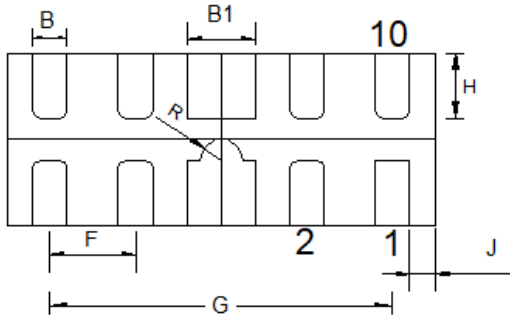
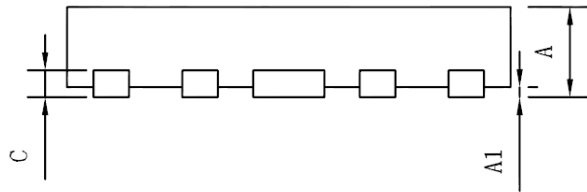
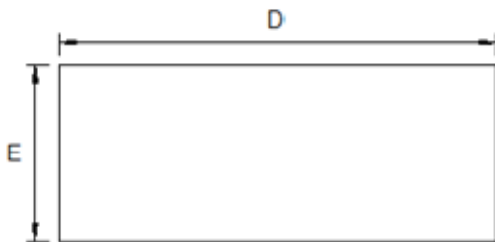


Fig.7 TLP Measurement

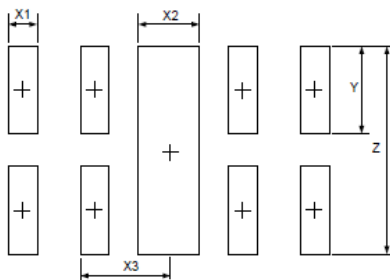


■ Outline Dimensions



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	0.40	0.45	0.50
A1	--	0.02	0.05
B	0.15	0.20	0.25
B1	0.35	0.40	0.45
C	0.10	0.15	0.20
D	2.45	2.50	2.55
E	0.95	1.00	1.05
F	0.50 BSC		
G	2.00 BSC		
H	0.30	0.38	0.46
R	0.125 BSC		
J	0.10	0.15	0.20

■ Soldering Footprint



SYM	DIMENSIONS	
	MILLIMETERS	INCHES
X1	0.200	0.008
X2	0.400	0.016
X3	0.600	0.024
Y	0.600	0.024
Z	1.400	0.056

Notes:

This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met.



SESDULC1E04P5B

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